Description

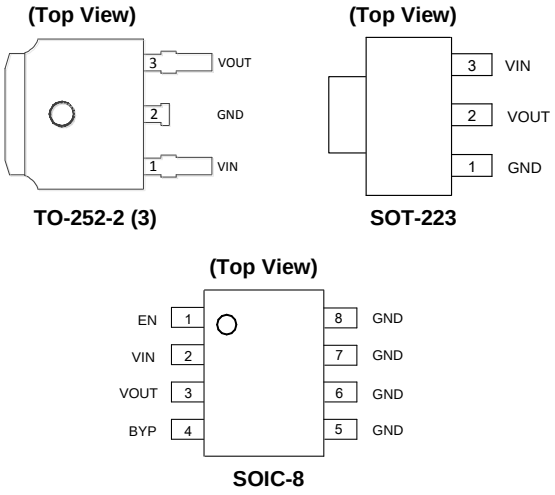
The AP2213 is a 500mA output current fixed voltage regulator which provides low noise, very low dropout voltage (typically 350mV at 500mA), very low standby current (1µA maximum), and excellent power supply ripple rejection (PSRR 75dB at 100Hz). This device is used in battery-powered applications, such as handsets and PDAs; and in noise sensitive applications, such as RF electronics.

The AP2213 features individual logic compatible enable/shutdown control inputs, a low power shutdown mode for extended battery life, over-current protection, over-temperature protection, and reversed current protection.

The AP2213 has 2.5V, 3.0V, and 3.3V versions.

The AP2213 is available in the TO-252-2 (3), SOIC-8, and SOT-223 packages.

Pin Assignments



Features

- Up to 500mA Output Current
- Low Standby Current
- Low Dropout Voltage: V_{DROP} = 350mV at 500mA
- High Output Accuracy: ±1%
- Good Ripple Rejection Ability: 75dB at 100Hz and I_{OUT} = 100µA
- Tight Load and Line Regulation
- Low Temperature Coefficient
- Over Current Protection
- Thermal Protection
- Reversed Current Protection
- Logic-Controlled Enable
- Moisture Sensitivity: Level 3 per J-STD-020
- Terminals: Finish—Matte Tin Plated Leads, Solderable per MIL-STD-202, Method 208 e3
- Weight:
  - TO252-2 (3): 0.312 grams (Approximate)
  - SOT-223: 0.116 grams (Approximate)
  - SOIC-8: 0.077 grams (Approximate)
- Lead-Free Packages: TO-252-2 (3), SOT-223, SOIC-8
  - **Totally Lead-Free; RoHS Compliant (Notes 1 & 2)**
- Lead-Free Packages, Available in "Green" Molding Compound: TO-252-2 (3), SOT-223, SOIC-8
  - **Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)**
  - **Halogen- and Antimony-Free. "Green" Device (Note 3)**
- **For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please contact us or your local Diodes representative.**
  https://www.diodes.com/quality/product-definitions/

Applications

- Laptop, Notebook, and Palmtop Computer
- CD-ROM, CD-R/RW, DVD Driver
- Portable Electronic
- PC Peripheral

Notes:
1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

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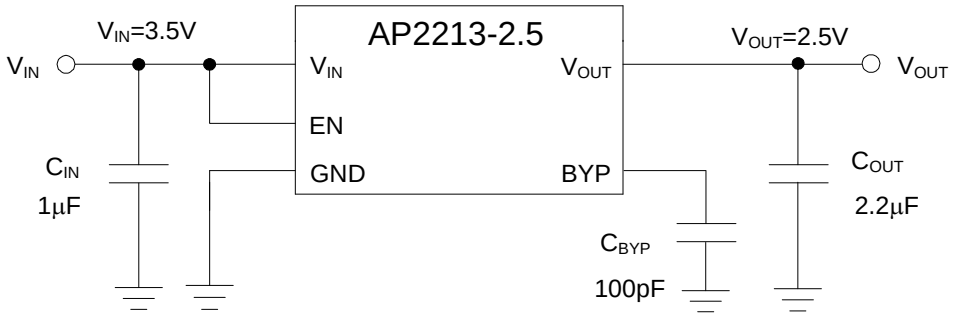
Typical Applications Circuit (Note 4)

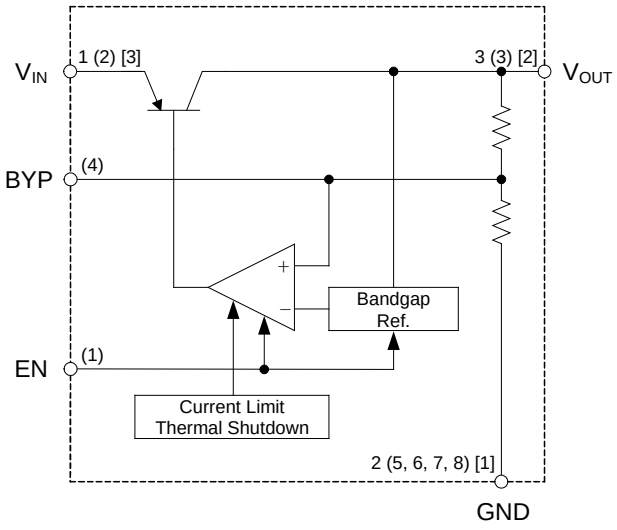


Notes: 4. Dropout voltage is 350mV when T_A = +25°C. In order to obtain a normal output voltage, V_{OUT}+0.35V is the minimum input voltage which will result in a low PSRR, imposing a bad influence on system. Therefore, the recommended input voltage is V_{OUT}+1V to 18V. For AP2213-2.5 version, its input voltage can be set from 3.5V(V_{OUT}+1V) to 18V.

Pin Descriptions

Pin Number			Pin Name	Function
TO-252-2 (3)	SOIC-8	SOT-223		
3	3	2	VOUT	Regulated output voltage
2	5, 6, 7, 8	1	GND	Ground
1	2	3	VIN	Input Voltage
—	1	—	EN	Enable input: CMOS or TTL compatible input. Logic high = enable, logic low = shutdown
—	4	—	BYP	Bypass capacitor for low noise operation

Functional Block Diagram



A (B) [C]
A for TO-252-2 (3)
B for SOIC-8
C for SOT-223

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Absolute Maximum Ratings (Note 5)

Symbol	Parameter	Rating		Unit
V_{IN}	Supply Input Voltage	20		V
V_{EN}	Enable Input Voltage	20		V
P_D	Power Dissipation	Internally Limited (Thermal Protection)		W
T_{LEAD}	Lead Temperature (Soldering, 10s)	+260		°C
T_J	Junction Temperature	+150		°C
T_{STG}	Storage Temperature	-65 to +150		°C
ESD	ESD (Machine Model)	300		V
	ESD (Human Body Model)	6000		
	ESD (Charge Device Model)	2000		
θ_{JA}	Thermal Resistance (No Heatsink)	TO-252-2 (3)	90	°C/W
		SOIC-8	160	
		SOT-223	108	

Notes: 5. Stresses greater than those listed under "*Absolute Maximum Ratings*" can cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "*Recommended Operating Conditions*" is not implied. Exposure to "*Absolute Maximum Ratings*" for extended periods can affect device reliability.

Recommended Operating Conditions

Symbol	Parameter	Min	Max	Unit
V_{IN}	Supply Input Voltage	2.5	18	V
V_{EN}	Enable Input Voltage	0	18	V
T_J	Operating Junction Temperature	-40	+125	°C

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AP2213-2.5 Electrical Characteristics (@V_{IN} = 3.5V, I_{OUT} = 100µA, C_{IN} = 1.0µF, C_{OUT} = 2.2µF, V_{EN} ≥ 2.0V, T_J = +25°C, **Bold** typeface applies over -40°C ≤ T_J ≤ +125°C (Note 6), unless otherwise specified.)

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
$\Delta V_{OUT}/V_{OUT}$	Output Voltage Accuracy	Variation from Specified V_{OUT}	-1	—	1	%
			-2	—	**2**	
$\Delta V_{OUT}/\Delta T$	Output Voltage Temperature Coefficient (Note 7)	—	—	**120**	—	µV/°C
$(\Delta V_{OUT}/V_{OUT})/\Delta T$			—	**48**	—	ppm/°C
V_{RLINE}	Line Regulation	V_{IN} = 3.5V to 13.2V	—	1.5	4.5	mV
			—	—	**12**	
V_{RLOAD}	Load Regulation (Note 8)	I_{OUT} = 0.1mA to 500mA	—	1	7	mV
			—	—	**17**	
V_{DROP}	Dropout Voltage (Note 9)	I_{OUT} = 100µA	—	15	50	mV
			—	—	**70**	
		I_{OUT} = 50mA	—	110	150	
			—	—	**230**	
		I_{OUT} = 100mA	—	140	250	
			—	—	**300**	
		I_{OUT} = 150mA	—	165	275	
			—	—	**350**	
		I_{OUT} = 300mA	—	250	400	
			—	—	**500**	
		I_{OUT} = 500mA	—	350	600	
			—	—	**700**	
I_{STD}	Standby Current	V_{EN} ≤ 0.4V (Shutdown)	—	0.01	1	µA
		V_{EN} ≤ 0.18V (Shutdown)	—	—	**5**	
I_{GND}	Ground Pin Current (Note 10)	V_{EN} ≥ 2.0V, I_{OUT} = 100µA	—	100	150	µA
			—	—	**180**	
		V_{EN} ≥ 2.0V, I_{OUT} = 50mA	—	350	600	
			—	—	**800**	
		V_{EN} ≥ 2.0V, I_{OUT} = 150mA	—	1.3	1.9	mA
			—	—	**2.5**	
		V_{EN} ≥ 2.0V, I_{OUT} = 300mA	—	4	10	
			—	—	**15**	
		V_{EN} ≥ 2.0V, I_{OUT} = 500mA	—	11	20	
			—	—	**28**	

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AP2213-2.5 Electrical Characteristics (cont.) (@V_{IN} = 3.5V, I_{OUT} = 100µA, C_{IN} = 1.0µF, C_{OUT} = 2.2µF, V_{EN} ≥ 2.0V, T_J = +25°C, **Bold** typeface applies over -40°C ≤ T_J ≤ +125°C (Note 6), unless otherwise specified.)

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
PSRR	Ripple Rejection	f = 100Hz, I_{OUT} = 100µA	—	75	—	dB
I_{LIMIT}	Current Limit	V_{OUT} = 0V	—	**700**	1000	mA
e_{no}	Output Noise	I_{OUT} = 50mA, C_{OUT} = 2.2µF, 100pF from BYP to GND	—	260	—	$nV/\sqrt{Hz}$
V_{IL}	Enable Input Logic-Low Voltage	Regulator Shutdown	—	—	0.4	V
			—	—	**0.18**	
V_{IH}	Enable Input Logic-High Voltage	Regulator Enabled	**2.0**	—	—	V
I_{IL}	Enable Input Logic-Low Current	V_{IL} ≤ 0.4V	—	0.01	1	µA
		V_{IL} ≤ 0.18V	—	—	**2**	
I_{IH}	Enable Input Logic-High Current	V_{IH} ≥ 2.0V	—	5	20	µA
		V_{IH} ≥ 2.0V	—	—	**25**	
θ_{JC}	Thermal Resistance	TO-252-2 (3)	—	20	—	°C/W
		SOIC-8	—	45	—	
		SOT-223	—	31	—	

Notes:
6. Specifications in bold type are limited to -40°C ≤ T_J ≤ +125°C. Limits over temperature are guaranteed by design, but not tested in production.
7. Output voltage temperature coefficient is defined as the worst case voltage change divided by the total temperature range.
8. Regulation is measured at constant junction temperature using low duty cycle pulse testing. Parts are tested for load regulation in the load range from 0.1mA to 500mA. Changes in output voltage due to heating effects are covered by the thermal regulation specification.
9. Dropout voltage is defined as the input to output differential at which the output voltage drops 1% (T_J = +25°C) or 2% (-40°C ≤ T_J ≤ +125°C) below its nominal value measured at 1V differential.
10. Ground pin current is the regulator quiescent current plus pass transistor base current. The total current drawn from the supply is the sum of the load current plus the ground pin current.

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AP2213-3.0 Electrical Characteristics (@V_{IN} = 4V, I_{OUT} = 100µA, C_{IN} = 1.0µF, C_{OUT} = 2.2µF, V_{EN} ≥ 2.0V, T_J = +25°C, **Bold** typeface applies over -40°C ≤ T_J ≤ +125°C (Note 6), unless otherwise specified.)

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
$\Delta V_{OUT}/V_{OUT}$	Output Voltage Accuracy	Variation from Specified V_{OUT}	-1	—	1	%
			-2	—	**2**	
$\Delta V_{OUT}/\Delta T$	Output Voltage Temperature Coefficient (Note 7)	—	—	**120**	—	µV/°C
$(\Delta V_{OUT}/V_{OUT})/\Delta T$			—	**40**	—	ppm/°C
V_{RLINE}	Line Regulation	V_{IN} = 4V to 13.2V	—	1.5	4.5	mV
			—	—	**12**	
V_{RLOAD}	Load Regulation (Note 8)	I_{OUT} = 0.1mA to 500mA	—	1	8	mV
			—	—	**17**	
V_{DROP}	Dropout Voltage (Note 9)	I_{OUT} = 100µA	—	15	50	mV
			—	—	**70**	
		I_{OUT} = 50mA	—	110	150	
			—	—	**230**	
		I_{OUT} = 100mA	—	140	250	
			—	—	**300**	
		I_{OUT} = 150mA	—	165	275	
			—	—	**350**	
		I_{OUT} = 300mA	—	250	400	
			—	—	**500**	
		I_{OUT} = 500mA	—	350	600	
			—	—	**700**	
I_{STD}	Standby Current	V_{EN} ≤ 0.4V (Shutdown)	—	0.01	1	µA
		V_{EN} ≤ 0.18V (Shutdown)	—	—	**5**	
I_{GND}	Ground Pin Current (Note 10)	V_{EN} ≥ 2.0V, I_{OUT} = 100µA	—	100	150	µA
			—	—	**180**	
		V_{EN} ≥ 2.0V, I_{OUT} = 50mA	—	350	600	
			—	—	**800**	
		V_{EN} ≥ 2.0V, I_{OUT} = 150mA	—	1.3	1.9	mA
			—	—	**2.5**	
		V_{EN} ≥ 2.0V, I_{OUT} = 300mA	—	4	10	
			—	—	**15**	
		V_{EN} ≥ 2.0V, I_{OUT} = 500mA	—	11	20	
			—	—	**28**	

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AP2213-3.0 Electrical Characteristics (cont.) (@V_{IN} = 4V, I_{OUT} = 100µA, C_{IN} = 1.0µF, C_{OUT} = 2.2µF, V_{EN} ≥ 2.0V, T_J = +25°C, **Bold** typeface applies over -40°C ≤ T_J ≤ +125°C (Note 6), unless otherwise specified.)

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
PSRR	Ripple Rejection	f = 100Hz, I_{OUT} = 100µA	—	75	—	dB
I_{LIMIT}	Current Limit	V_{OUT} = 0V	—	**700**	1000	mA
e_{no}	Output Noise	I_{OUT} = 50mA, C_{OUT} = 2.2µF, 100pF from BYP to GND	—	260	—	$nV/\sqrt{Hz}$
V_{IL}	Enable Input Logic-Low Voltage	Regulator Shutdown	—	—	0.4	V
			—	—	**0.18**	
V_{IH}	Enable Input Logic-High Voltage	Regulator Enabled	**2.0**	—	—	V
I_{IL}	Enable Input Logic-Low Current	V_{IL} ≤ 0.4V	—	0.01	1	µA
		V_{IL} ≤ 0.18V	—	—	**2**	
I_{IH}	Enable Input Logic-High Current	V_{IH} ≥ 2.0V	—	5	20	µA
		V_{IH} ≥ 2.0V	—	—	**25**	
θ_{JC}	Thermal Resistance	TO-252-2 (3)	—	20	—	°C/W
		SOIC-8	—	45	—	
		SOT-223	—	31	—	

Notes:
6. Specifications in bold type are limited to -40°C ≤ T_J ≤ +125°C. Limits over temperature are guaranteed by design, but not tested in production.
7. Output voltage temperature coefficient is defined as the worst case voltage change divided by the total temperature range.
8. Regulation is measured at constant junction temperature using low duty cycle pulse testing. Parts are tested for load regulation in the load range from 0.1mA to 500mA. Changes in output voltage due to heating effects are covered by the thermal regulation specification.
9. Dropout voltage is defined as the input to output differential at which the output voltage drops 1% (T_J = +25°C) or 2% (-40°C ≤ T_J ≤ +125°C) below its nominal value measured at 1V differential.
10. Ground pin current is the regulator quiescent current plus pass transistor base current. The total current drawn from the supply is the sum of the load current plus the ground pin current.

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AP2213-3.3 Electrical Characteristics (@V_{IN} = 4.3V, I_{OUT} = 100µA, C_{IN} = 1.0µF, C_{OUT} = 2.2µF, V_{EN} ≥ 2.0V, T_J = +25°C, **Bold** typeface applies over -40°C ≤ T_J ≤ +125°C (Note 6), unless otherwise specified.)

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
$\Delta V_{OUT}/V_{OUT}$	Output Voltage Accuracy	Variation from Specified V_{OUT}	-1	—	1	%
			-2	—	**2**	
$\Delta V_{OUT}/\Delta T$	Output Voltage Temperature Coefficient (Note 7)	—	—	**120**	—	µV/°C
$(\Delta V_{OUT}/V_{OUT})/\Delta T$			—	**36.3**	—	ppm/°C
V_{RLINE}	Line Regulation	V_{IN} = 4.3V to 13.2V	—	1.5	4.5	mV
			—	—	**12**	
V_{RLOAD}	Load Regulation (Note 8)	I_{OUT} = 0.1mA to 500mA	—	1	9	mV
			—	—	**18**	
V_{DROP}	Dropout Voltage (Note 9)	I_{OUT} = 100µA	—	15	50	mV
			—	—	**70**	
		I_{OUT} = 50mA	—	110	150	
			—	—	**230**	
		I_{OUT} = 100mA	—	140	250	
			—	—	**300**	
		I_{OUT} = 150mA	—	165	275	
			—	—	**350**	
		I_{OUT} = 300mA	—	250	400	
			—	–	**500**	
		I_{OUT} = 500mA	—	350	600	
			—	—	**700**	
I_{STD}	Standby Current	V_{EN} ≤ 0.4V (Shutdown)	—	0.01	1	µA
		V_{EN} ≤ 0.18V (Shutdown)	—	—	**5**	
I_{GND}	Ground Pin Current (Note 10)	V_{EN} ≥ 2.0V, I_{OUT} = 100µA	—	100	150	µA
			—	—	**180**	
		V_{EN} ≥ 2.0V, I_{OUT} = 50mA	—	350	600	
			—	—	**800**	
		V_{EN} ≥ 2.0V, I_{OUT} = 150mA	—	1.3	1.9	mA
			—	—	**2.5**	
		V_{EN} ≥ 2.0V, I_{OUT} = 300mA	—	4	10	
			—	—	**15**	
		V_{EN} ≥ 2.0V, I_{OUT} = 500mA	—	11	20	
			—	—	**28**	

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AP2213-3.3 Electrical Characteristics (cont.) (@V_{IN} = 4.3V, I_{OUT} = 100µA, C_{IN} = 1.0µF, C_{OUT} = 2.2µF, V_{EN} ≥ 2.0V, T_J = +25°C, **Bold** typeface applies over -40°C ≤ T_J ≤ +125°C (Note 6), unless otherwise specified.)

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
PSRR	Ripple Rejection	f = 100Hz, I_{OUT} = 100µA	—	75	—	dB
I_{LIMIT}	Current Limit	V_{OUT} = 0V	—	**700**	1000	mA
e_{no}	Output Noise	I_{OUT} = 50mA, C_{OUT} = 2.2µF, 100pF from BYP to GND	—	260	—	$nV/\sqrt{Hz}$
V_{IL}	Enable Input Logic-Low Voltage	Regulator Shutdown	—	—	0.4	V
			—	—	**0.18**	
V_{IH}	Enable Input Logic-High Voltage	Regulator Enabled	**2.0**	—	—	V
I_{IL}	Enable Input Logic-Low Current	V_{IL} ≤ 0.4V	—	0.01	1	µA
		V_{IL} ≤ 0.18V	—	—	**2**	
I_{IH}	Enable Input Logic-High Current	V_{IH} ≥ 2.0V	—	5	20	µA
		V_{IH} ≥ 2.0V	—	—	**25**	
θ_{JC}	Thermal Resistance	TO-252-2 (3)	—	20	—	°C/W
		SOIC-8	—	45	—	
		SOT-223	—	31	—	

Notes:
6. Specifications in bold type are limited to -40°C ≤ T_J ≤ +125°C. Limits over temperature are guaranteed by design, but not tested in production.
7. Output voltage temperature coefficient is defined as the worst case voltage change divided by the total temperature range.
8. Regulation is measured at constant junction temperature using low duty cycle pulse testing. Parts are tested for load regulation in the load range from 0.1mA to 500mA. Changes in output voltage due to heating effects are covered by the thermal regulation specification.
9. Dropout voltage is defined as the input to output differential at which the output voltage drops 1% (T_J = +25°C) or 2% (-40°C ≤ T_J ≤ +125°C) below its nominal value measured at 1V differential.
10. Ground pin current is the regulator quiescent current plus pass transistor base current. The total current drawn from the supply is the sum of the load current plus the ground pin current.

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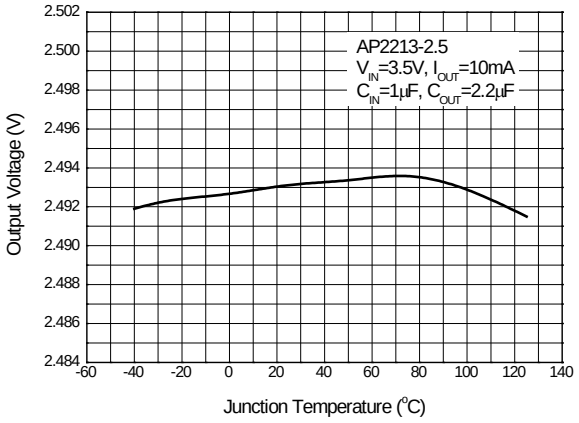
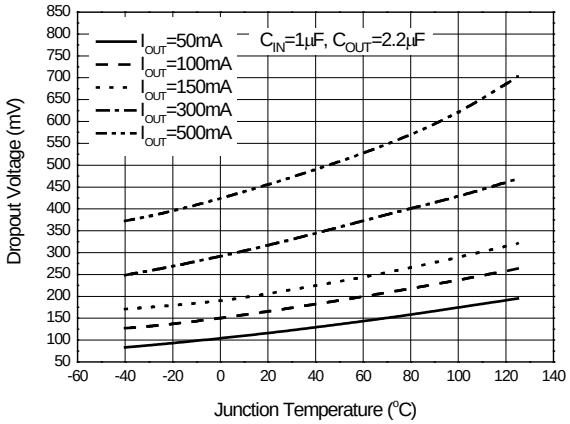
Performance Characteristics

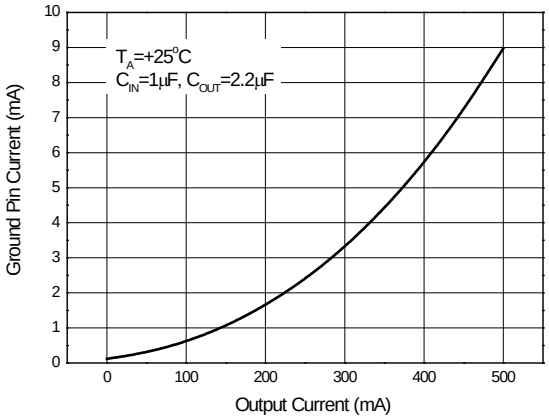
Output Voltage vs. Junction Temperature



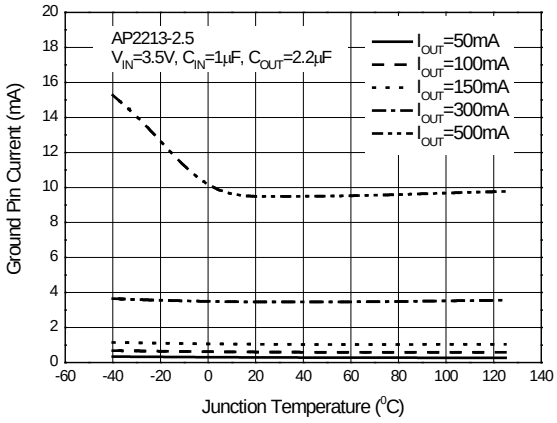
Dropout Voltage vs. Junction Temperature



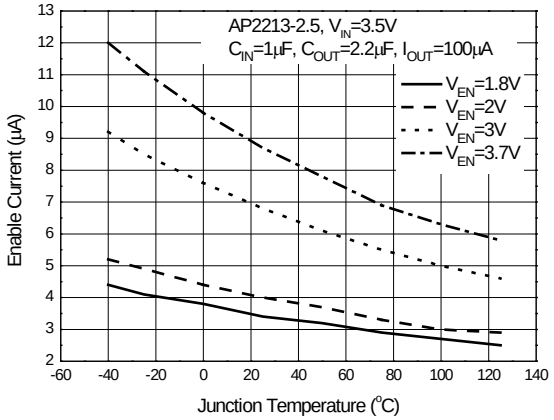
Ground Pin Current vs. Output Current



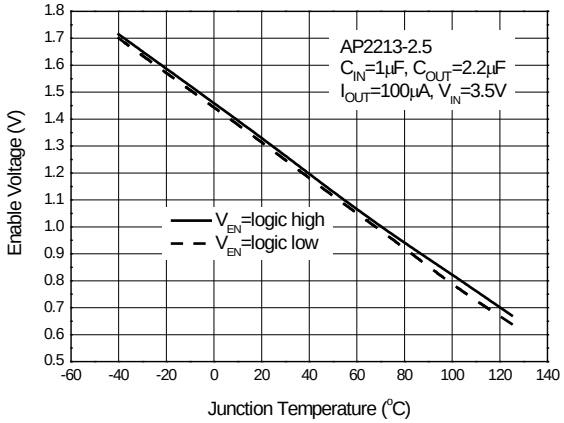
Ground Pin Current vs. Junction Temperature



Enable Current vs. Junction Temperature



Enable Voltage vs. Junction Temperature



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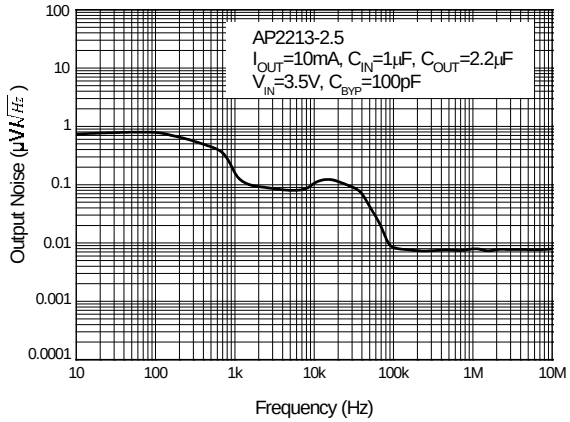
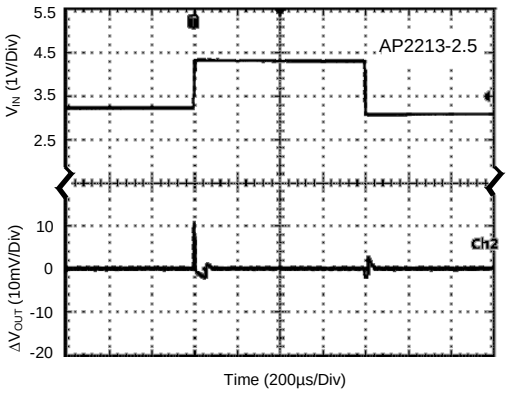
Performance Characteristics (cont.)

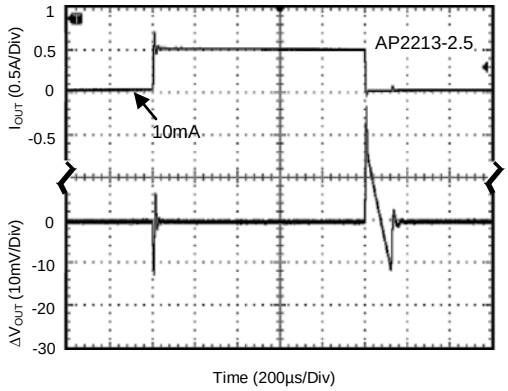
Output Noise vs. Frequency



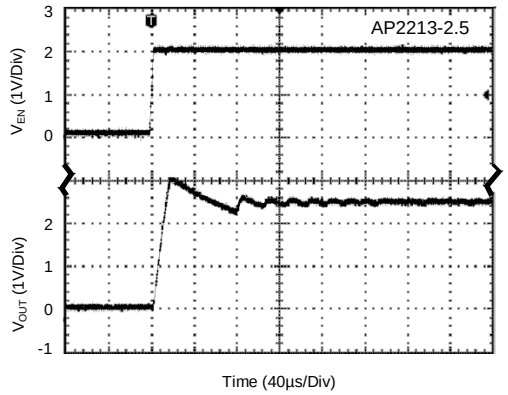
Line Transient
(Conditions: V_{IN}=3.4V to 4.4V, V_{EN}=2V, I_{OUT}=100µA C_{BYP}=100pF, C_{OUT}=2.2µF)



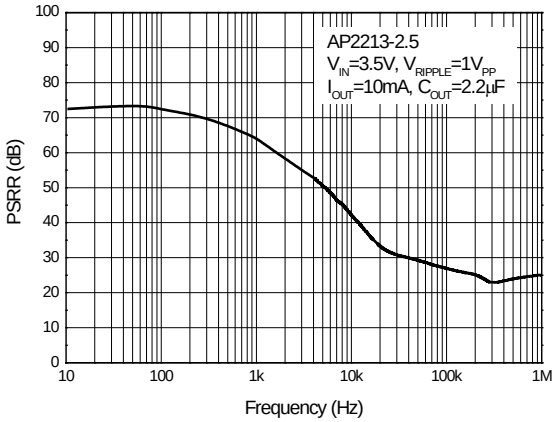
Load Transient
(Conditions: V_{IN}=3.5V, C_{BYP}=100pF, V_{EN}=2V, I_{OUT}=10mA to 500mA, C_{IN}=1.0µF, C_{OUT}=2.2µF)



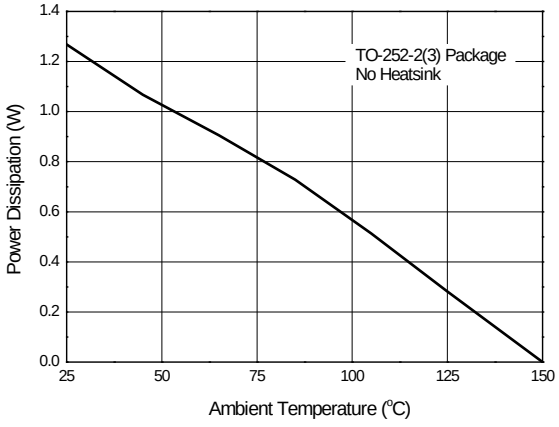
V_{EN} vs. V_{OUT}
(Conditions: V_{EN}=0V to 2V, V_{IN}=3.5V, I_{OUT}=30mA, C_{BYP}=open, C_{IN}=1.0µF, C_{OUT}=2.2µF)



PSRR vs. Frequency



Power Dissipation vs. Ambient Temperature



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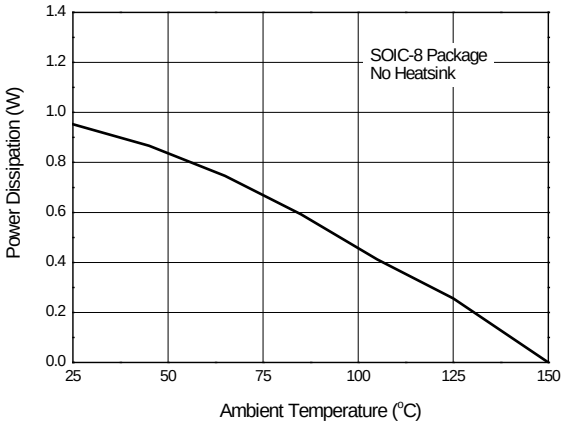
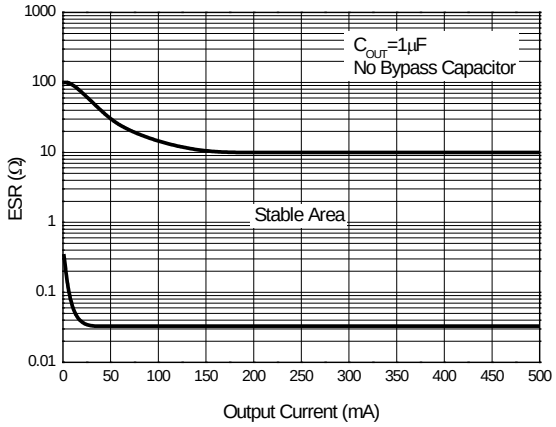
Performance Characteristics (cont.)

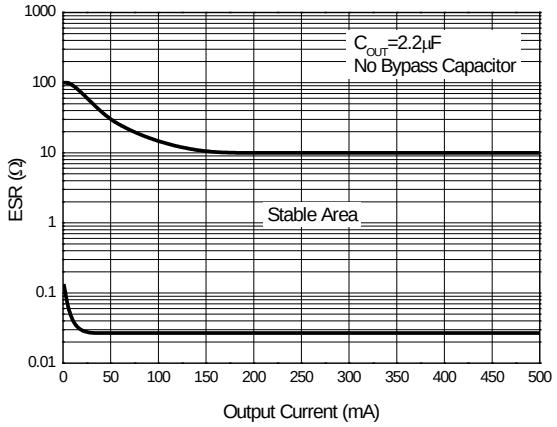
Power Dissipation vs. Ambient Temperature



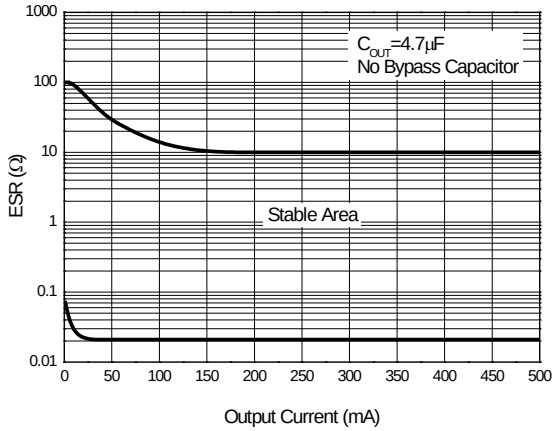
ESR vs. Output Current



ESR vs. Output Current



ESR vs. Output Current



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Application Information

Input Capacitor

A 1μF minimum capacitor is recommended to be placed between V_{IN} and GND.

Output Capacitor

An output capacitor is required to prevent oscillation. A 1μF minimum is recommended when C_{BYP} is unused. A 2.2μF minimum is recommended when C_{BYP} is 100pF. The output capacitor may be increased to improve transient response.

Noise Bypass Capacitor

A bypass capacitor is connected to the internal voltage reference. A small capacitor connected from BYP to GND makes this reference quiet, resulting in a significant reduction in output noise, but the ESR stable area will be narrowed. In order to keep the output stability, it is recommended to use the bypass capacitor no more than 100pF.

The start-up speed of the AP2213 is inversely proportional to the value of the reference bypass capacitor. In some cases, if output noise is not a major concern and rapid turn-on is necessary, omit C_{BYP} and leave BYP open.

Power Dissipation

Thermal shutdown may take place if the maximum power dissipation is exceeded in application. Under all possible operating conditions, the junction temperature must be within the range specified under absolute maximum ratings to avoid thermal shutdown.

To determine if the power dissipated in the regulator reaches the maximum power dissipation (see Figure Power Dissipation vs. Ambient Temperature (SOIC-8 Package), ESR vs. Output Current (C_{OUT} = 1μF)), use:

$$T_J = P_D*\theta_{JA} + T_A$$

$$P_D = (V_{IN}-V_{OUT})*I_{OUT}+V_{IN}*I_{GND}$$

Where: $T_J \le T_{J(max)}$, $T_{J(max)}$ is absolute maximum ratings for the junction temperature; $V_{IN}*I_{GND}$ can be ignored due to its small value.

$T_{J(max)}$ is +150°C, θ_{JA} is 90°C/W for TO-252-2 (3) package and 160°C/W for SOIC-8 package.

Example: For 2.5V version packaged in SOIC-8, I_{OUT} = 500mA, T_A = +50°C, $V_{IN(Max)}$ is:

(150°C-50°C)/(0.5A*160°C/W)+2.5V=3.75V

Therefore, for good performance, please make sure that the input voltage is less than 3.75V without heatsink when T_A = +50°C.

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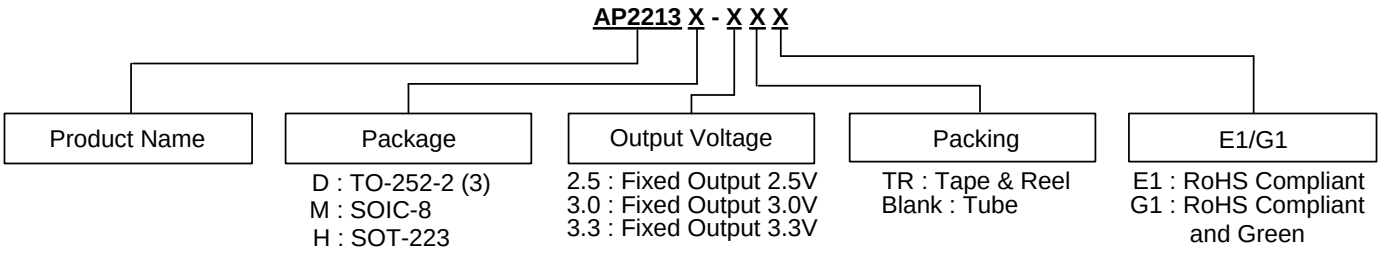
Ordering Information



	Package	Temperature Range	Part Number		Marking ID		Packing
			RoHS Compliant	RoHS Compliant and Green	RoHS Compliant	RoHS Compliant and Green	
Lead-Free Lead-Free Green	TO-252-2 (3)	-40 to +125°C	AP2213D-2.5E1	AP2213D-2.5G1	AP2213D-2.5E1	AP2213D-2.5G1	100/Tube
			AP2213D-2.5TRE1	AP2213D-2.5TRG1	AP2213D-2.5E1	AP2213D-2.5G1	2500/Tape & Reel
			AP2213D-3.0E1	AP2213D-3.0G1	AP2213D-3.0E1	AP2213D-3.0G1	100/Tube
			AP2213D-3.0TRE1	AP2213D-3.0TRG1	AP2213D-3.0E1	AP2213D-3.0G1	2500/Tape & Reel
			AP2213D-3.3E1	AP2213D-3.3G1	AP2213D-3.3E1	AP2213D-3.3G1	100/Tube
			AP2213D-3.3TRE1	AP2213D-3.3TRG1	AP2213D-3.3E1	AP2213D-3.3G1	2500/Tape & Reel
Lead-Free Lead-Free Green	SOIC-8	-40 to +125°C	AP2213M-2.5E1	AP2213M-2.5G1	2213M-2.5E1	2213M-2.5G1	100/Tube
			AP2213M-2.5TRE1	AP2213M-2.5TRG1	2213M-2.5E1	2213M-2.5G1	2500/Tape & Reel
			AP2213M-3.0E1	AP2213M-3.0G1	2213M-3.0E1	2213M-3.0G1	100/Tube
			AP2213M-3.0TRE1	AP2213M-3.0TRG1	2213M-3.0E1	2213M-3.0G1	2500/Tape & Reel
			AP2213M-3.3E1	AP2213M-3.3G1	2213M-3.3E1	2213M-3.3G1	100/Tube
			AP2213M-3.3TRE1	AP2213M-3.3TRG1	2213M-3.3E1	2213M-3.3G1	2500/Tape & Reel
Lead-Free Lead-Free Green	SOT-223	-40 to +125°C	AP2213H-2.5TRE1	AP2213H-2.5TRG1	EH13C	GH13C	4000/Tape & Reel
			AP2213H-3.0TRE1	AP2213H-3.0TRG1	EH13E	GH13E	4000/Tape & Reel
			AP2213H-3.3TRE1	AP2213H-3.3TRG1	EH13F	GH13F	4000/Tape & Reel

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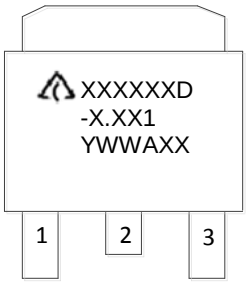
Marking Information

(1) TO-252-2 (3)

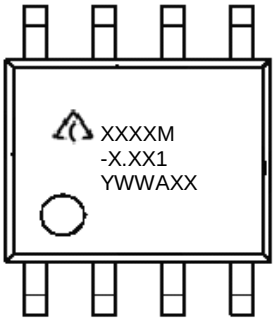
(Top View)



First and Second Lines: Logo and Marking ID
(See Ordering Information)
Third Line: Date Code
Y: Year
WW: Work Week of Molding
A: Assembly House Code
XX: 7th and 8th Digits of Batch Number

(2) SOIC-8

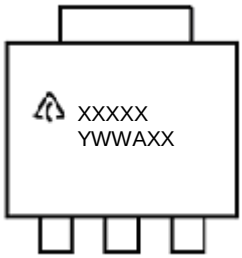
(Top View)



First and Second Lines: Logo and Marking ID
(See Ordering Information)
Third line: Date Code
Y: Year
WW: Work Week of Molding
A: Assembly House Code
XX: 7th and 8th Digits of Batch Number

(3) SOT-223

(Top View)



First Line: Logo and Marking ID
(See Ordering Information)
Second Line: Date Code
Y: Year
WW: Work Week of Molding
A: Assembly House Code
XX: 7th and 8th Digits of Batch Number

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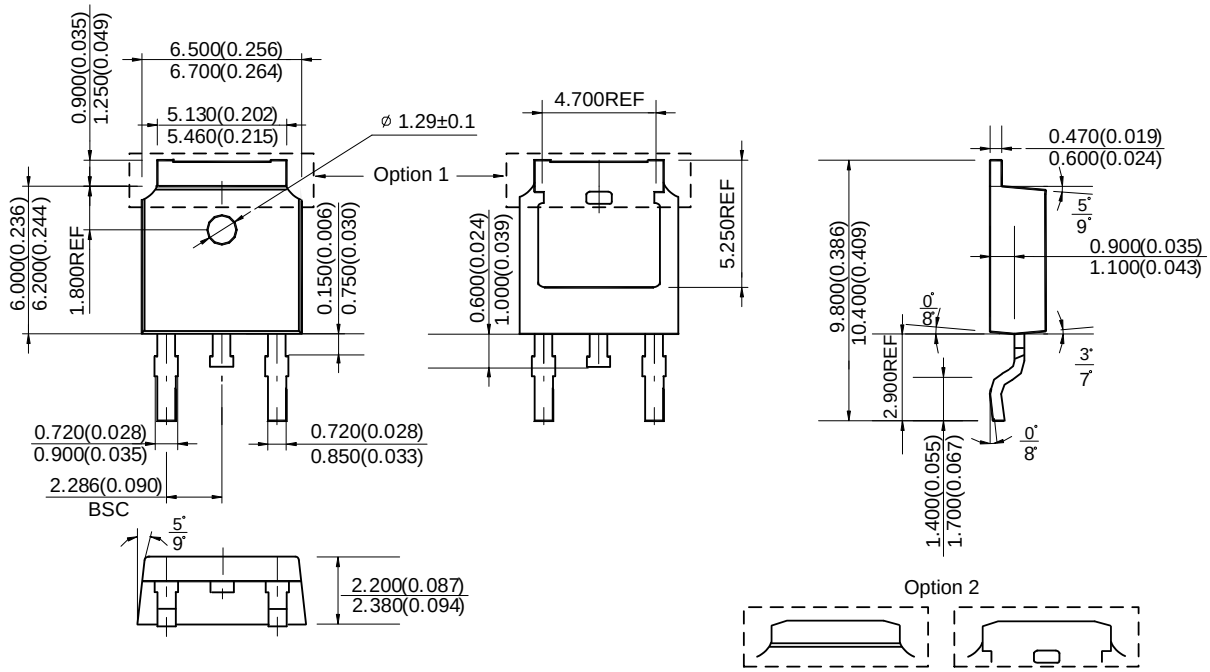
Package Outline Dimensions (All dimensions in mm(inch).)

(1) Package Type: TO-252-2 (3)



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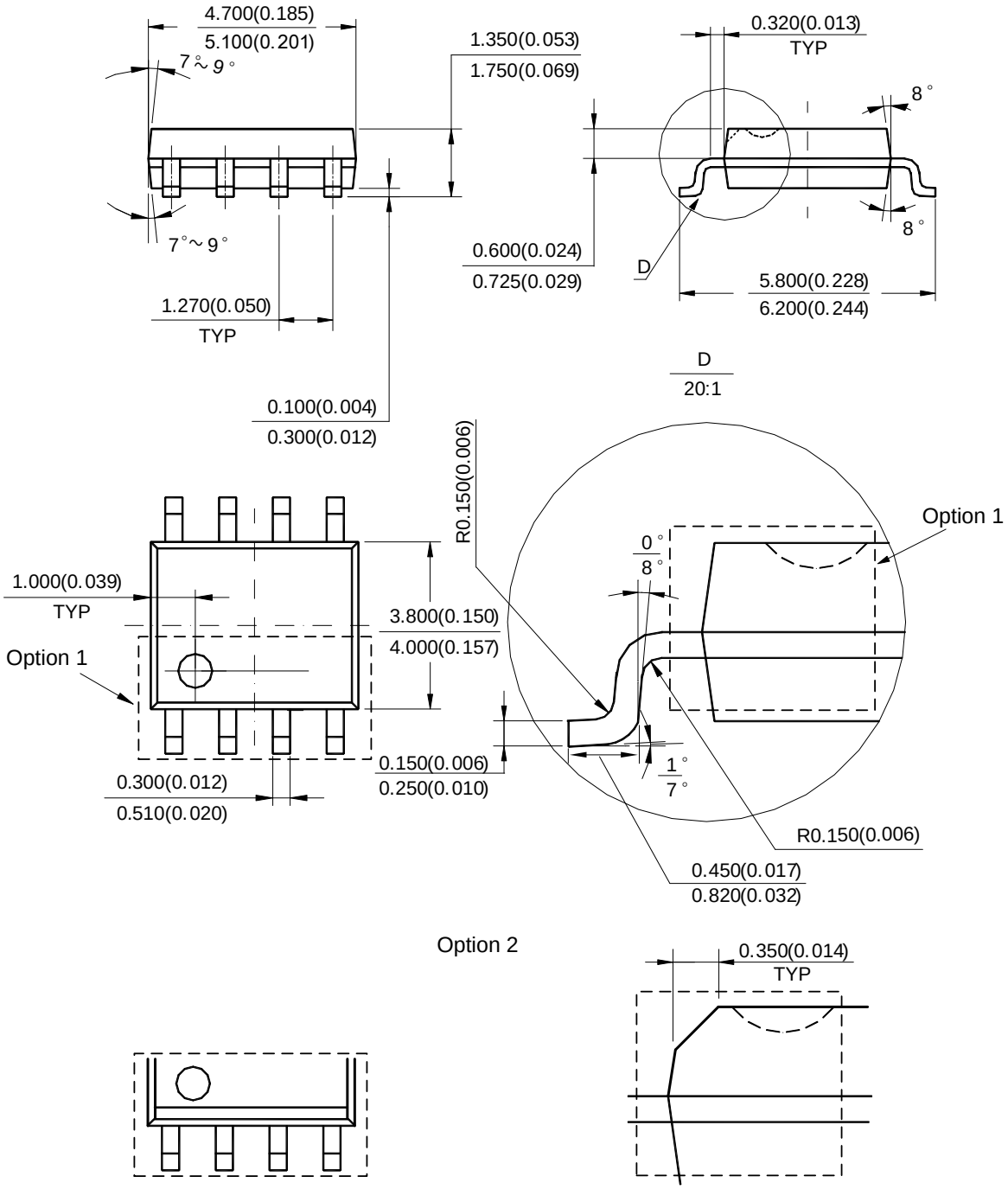
Package Outline Dimensions (All dimensions in mm(inch).) (continued)

(2) Package Type: SOIC-8



Note: Eject hole, oriented hole and mold mark is optional.

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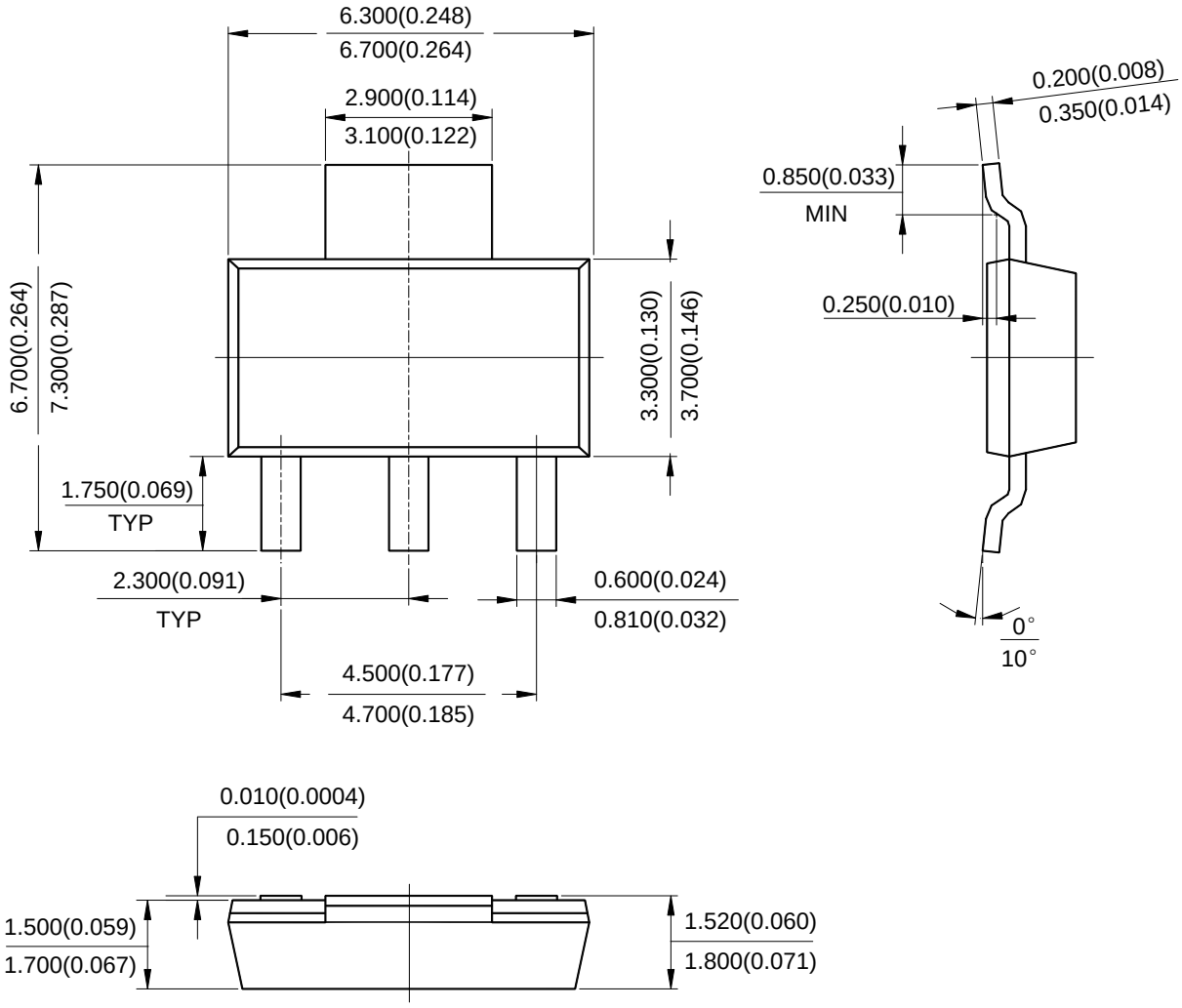
Package Outline Dimensions (All dimensions in mm(inch).) (continued)

(3) Package Type: SOT-223



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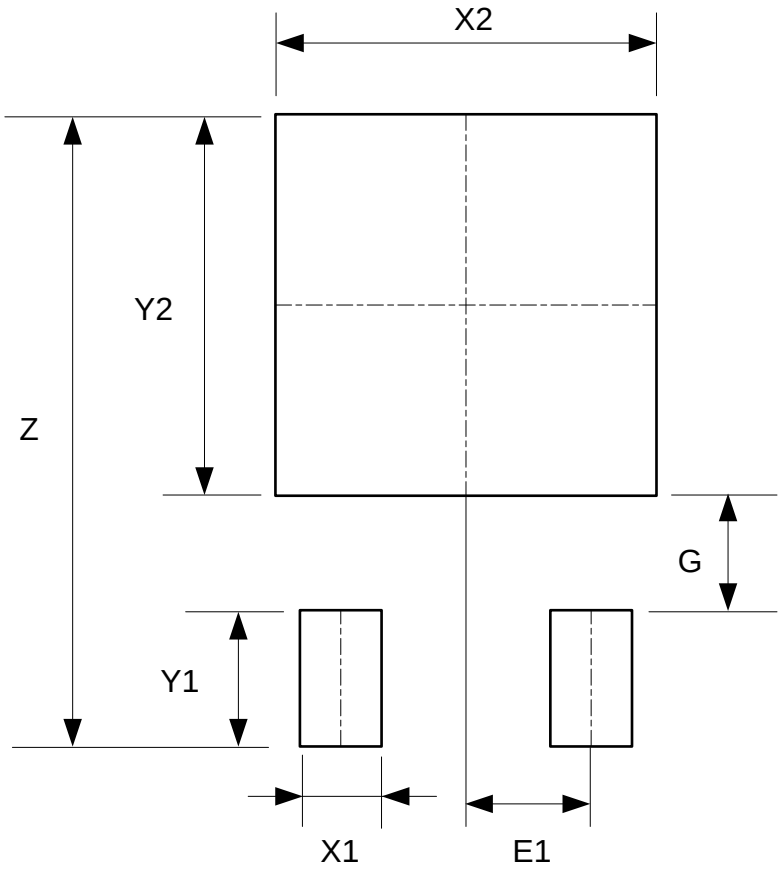
Suggested Pad Layout

(1) Package Type: TO-252-2 (3)



Dimensions	Z (mm)/(inch)	X1 (mm)/(inch)	X2=Y2 (mm)/(inch)	Y1 (mm)/(inch)	G (mm)/(inch)	E1 (mm)/(inch)
Value	11.600/0.457	1.500/0.059	7.000/0.276	2.500/0.098	2.100/0.083	2.300/0.091

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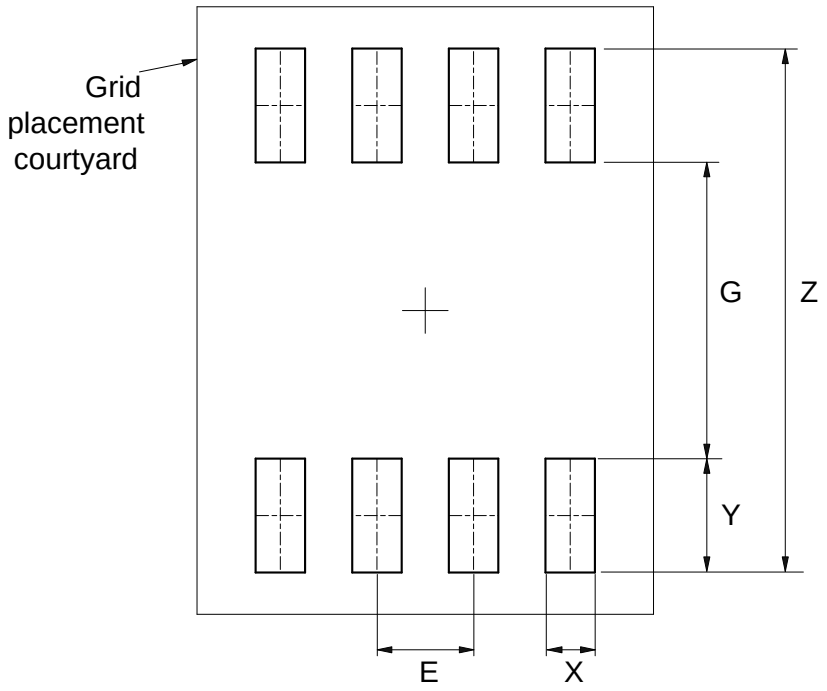
Suggested Pad Layout (continued)

(2) Package Type: SOIC-8



Dimensions	Z (mm)/(inch)	G (mm)/(inch)	X (mm)/(inch)	Y (mm)/(inch)	E (mm)/(inch)
Value	6.900/0.272	3.900/0.154	0.650/0.026	1.500/0.059	1.270/0.050

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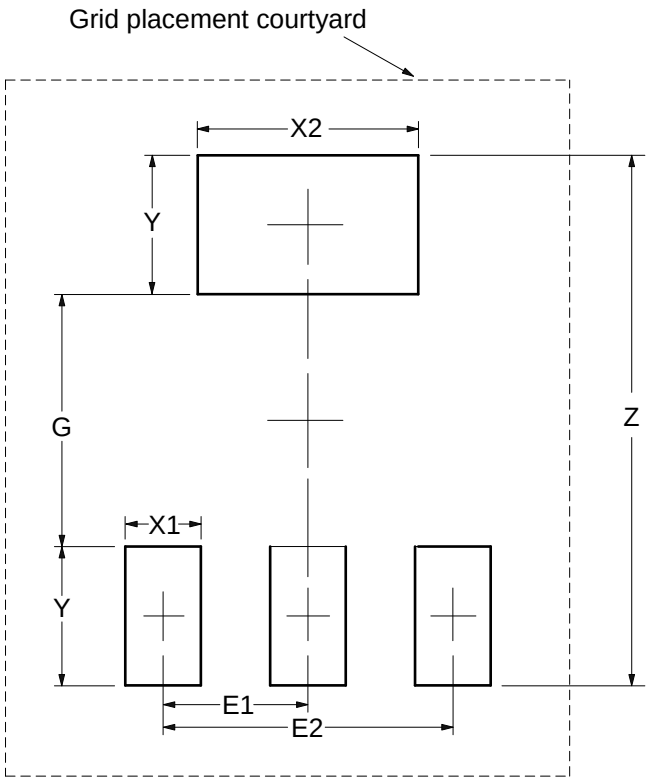
Suggested Pad Layout (continued)

(3) Package Type: SOT-223



Dimensions	Z (mm)/(inch)	G (mm)/(inch)	X1 (mm)/(inch)	X2 (mm)/(inch)	Y (mm)/(inch)	E1 (mm)/(inch)	E2 (mm)/(inch)
Value	8.400/0.331	4.000/0.157	1.200/0.047	3.500/0.138	2.200/0.087	2.300/0.091	4.600/0.181

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